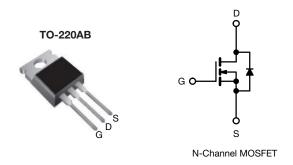
SiHP155N60EF



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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.137		
Q _g max. (nC)	38			
Q _{gs} (nC)	10			
Q _{gd} (nC)	6			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP155N60EF-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain surrant $(T_{\rm e} = 150 ^{\circ}{\rm C})$	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	21		
Continuous drain current ($T_J = 150 \ ^{\circ}C$)				14	А	
Pulsed drain current ^a			I _{DM}	43		
Linear derating factor				1.42	W/°C	
Single pulse avalanche energy ^b			E _{AS}	111	mJ	
Maximum power dissipation			PD	179	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100		
Reverse diode dv/dt ^d				50	V/ns	
Soldering recommendations (peak temperature) ^c		For 10 s		260	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2.8 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	-		62					
Maximum junction-to-case (drain)	R _{thJC}	-		0.7	0.7		°C/W		
	•	•							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	ise noted)							
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNI	
Static								I	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.62	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μA	3.0	-	5.0	V	
		,	$V_{GS} = \pm 20$	V	-	-	± 100	nA	
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30$	V	-	-	± 1	μA	
			= 480 V, V _G		-	-	1	μA	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	-	2	mA		
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	1	₀ = 10 A	-	0.137	0.159	Ω	
Forward transconductance	9 _{fs}	V _{DS} = 10 V, I _D = 10 A		-	9.2	-	S		
Dynamic		•						1	
Input capacitance	C _{iss}	$V_{GS} = 0 V, V_{DS} = 100 V, f = 100 KHz$		-	1465	-	pF		
Output capacitance	C _{oss}			-	56	-			
Reverse transfer capacitance	C _{rss}			-	1	-			
Effective output capacitance, energy related	C _{o(er)}	- V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	61	-			
Effective output capacitance, time related	C _{o(tr)}			-	356	-			
Total gate charge	Qg	V _{GS} = 10 V I _D = 10 A, V _{DS} = 480 V		-	25	38	nC		
Gate-source charge	Q _{gs}			-	10	-			
Gate-drain charge	Q _{gd}				-	6	-		
Turn-on delay time	t _{d(on)}	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 10 \text{ A}, \\ V_{GS} = 10 \text{ V}, \text{ R}_{g} = 10.1 \Omega$		-	20	40			
Rise time	t _r			-	27	54	- ns		
Turn-off delay time	t _{d(off)}			-	28	56			
Fall time	t _f			-	17	34			
Gate input resistance	Rg	f = 1 MHz, open drain		0.4	0.9	1.8	Ω		
Drain-Source Body Diode Characteris									
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21			
Pulsed diode forward current	I _{SM}			-	-	43	A		
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 10 A	, V _{GS} = 0 V	-	-	1.2	V	
Reverse recovery time	t _{rr}				-	95	190	ns	
Reverse recovery charge	Q _{rr}		5 °C, I _F = I _S		-	0.5	1.0	μC	
Reverse recovery current	I _{RRM}	di/dt = 100 A/µs, V _R = 400 V		-	12	-	A		



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

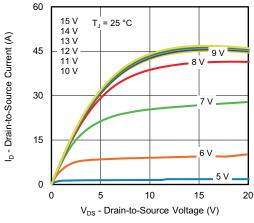


Fig. 1 - Typical Output Characteristics

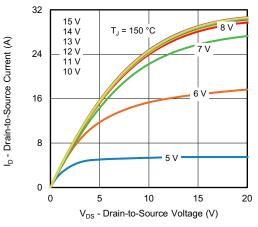


Fig. 2 - Typical Output Characteristics

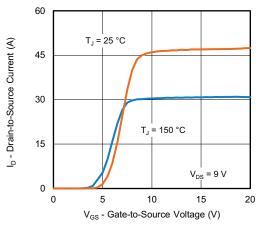


Fig. 3 - Typical Transfer Characteristics

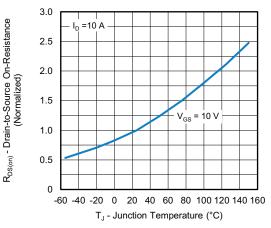


Fig. 4 - Normalized On-Resistance vs. Temperature

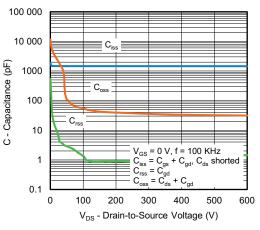
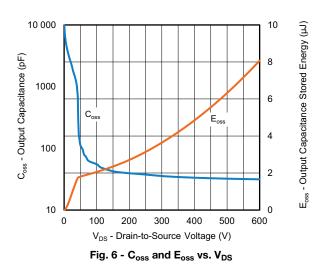


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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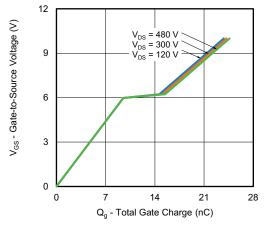


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

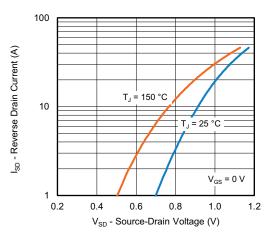


Fig. 8 - Typical Source-Drain Diode Forward Voltage

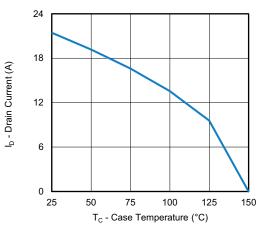


Fig. 9 - Maximum Drain Current vs. Case Temperature

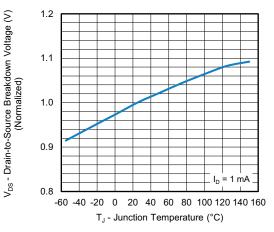


Fig. 10 - Temperature vs. Drain-to-Source Voltage

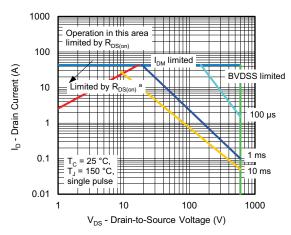


Fig. 11 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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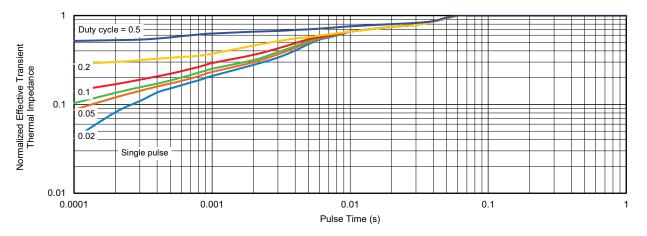


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

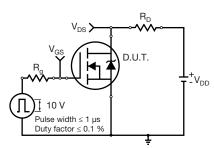


Fig. 13 - Switching Time Test Circuit

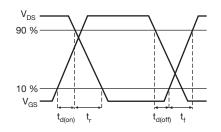


Fig. 14 - Switching Time Waveforms

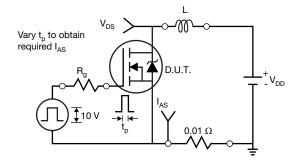
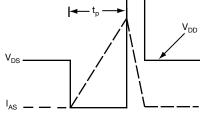


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

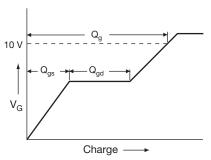
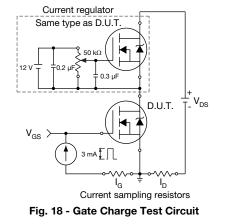


Fig. 17 - Basic Gate Charge Waveform

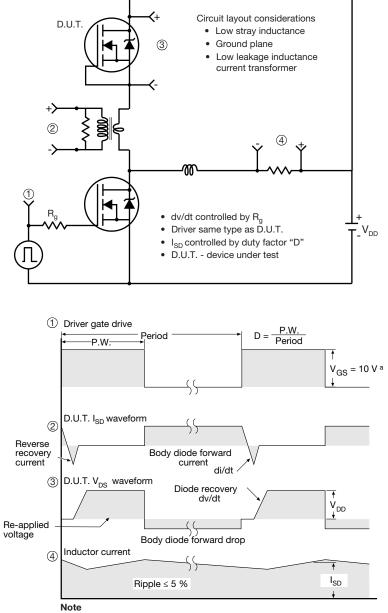


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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

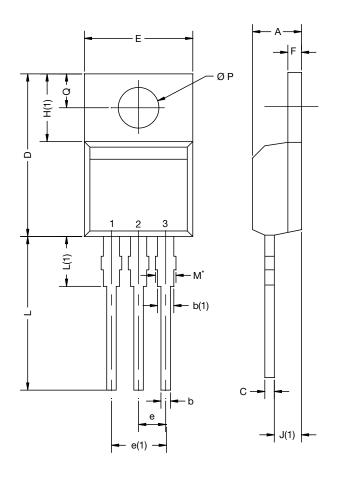
Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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